CMOS Digital Integrated Circuits Silicon Monolithic

# TC7USB40FT

#### 1. Functional Description

Dual SPDT USB Switch

#### 2. General

The TC7USB40FT is high-speed CMOS dual 1-2 multiplexer/demultiplexer. The low ON-resistance and the low capacitance of the switch allow connections to USB2.0 (480Mbps) application.

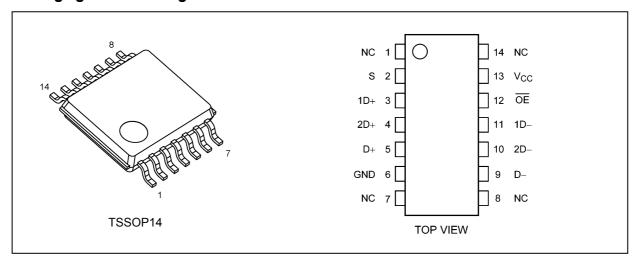
This device consists of dual individual two-inputs multiplexer/demultiplexer with common select input (S) and output enable  $(\overline{OE})$ . The D+/D- inputs is connected to the 1D+/1D- or 2D+/2D- outputs determined by the combination both the select input (S) and output enable  $(\overline{OE})$ . When the output enable  $(\overline{OE})$  input is held high level, the switches are open with regardless the state of select inputs and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.

#### 3. Features

- (1) Supply voltage:  $V_{CC} = 2.3 \text{ to } 4.3 \text{ V}$
- (2) Switch terminal ON-capacitance:  $C_{I/O} = 5$  pF Switch ON (typ.) @ $V_{CC} = 3.3$  V
- (3) ON-resistance:  $R_{ON} = 4.5 \Omega$  (typ.) @ $V_{CC} = 3 V$ ,  $V_{IS} = 0 V$
- (4)  $R_{ON}$  flatness:  $R_{ON(flat)} = 1.3 \Omega$  (typ.)@ $V_{CC} = 3 V$
- (5) Difference of ON-resistance between switches:  $\Delta R_{ON} = 0.35 \Omega$  (typ.)@ $V_{CC} = 3 V$
- (6) ESD performance: Machine model ≥ ±200 V, Human body model ≥ ±8000 V
- (7) Power-down protection provided on all inputs and outputs.
- (8) Package: TSSOP14

#### 4. Packaging and Pin Assignment





## 5. Marking

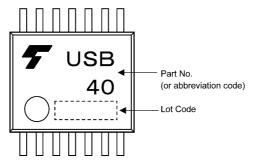


Fig. 5.1 Marking (Top view)

## 6. Block Diagram

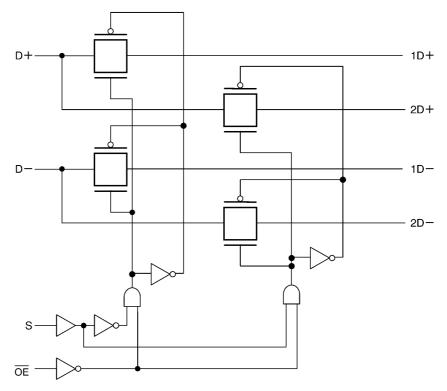


Fig. 6.1 Block Diagram

## 7. Principle of Operation

## 7.1. Truth Table

Input OE	Input S	Function			
L	L	D+ port = 1D+ port, D- Port = 1D- Port			
L	Н	D+ port = 2D+ port, D- Port = 2D- Port			
Н	Х	Disconnect			

X: Don't care



#### 8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	-0.5 to 4.6	V
Input voltage (OE, S)	V <sub>IN</sub>			-0.5 to 4.6	
Switch I/O voltage	Vs		V <sub>CC</sub> = 0 V or Switch OFF	-0.5 to 4.6	
			Switch ON	0.5 to V <sub>CC</sub> +0.5	
Clamp diode current	I <sub>IK</sub>		Control input	-50	mA
			Switch	±50	
Switch I/O current	I <sub>S</sub>		_	50	
Power dissipation	P <sub>D</sub>			200	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>			±100	mA
Storage temperature	T <sub>stg</sub>			-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 9. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	2.3 to 4.3	V
Input voltage (OE, S)	V <sub>IN</sub>			0 to 4.3	
Switch I/O voltage	Vs		V <sub>CC</sub> = 0 V or Switch OFF	0 to 4.3	
			Switch ON	0 to V <sub>CC</sub>	
Operating temperature	T <sub>opr</sub>		_	-40 to 85	°C
Input rise time	dt/dv			0 to 10	ns/V
Input fall time				0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either  $V_{\text{CC}}$  or GND.



#### 10. Electrical Characteristics

## 10.1. DC Characteristics (Note) (Unless otherwise specified, $T_a$ = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage (OE, S)	V <sub>IH</sub>		_	2.3 to 3.0	0.50 × V <sub>CC</sub>	-	_	V
				3.0 to 4.3	0.46 × V <sub>CC</sub>	l	_	
Low-level input voltage (OE, S)	V <sub>IL</sub>		_	2.3 to 4.3	ı	l	0.25 × V <sub>CC</sub>	
Input leakage current (OE, S)	I <sub>IN</sub>		V <sub>IN</sub> = 0 to 4.3 V	2.3 to 4.3			±1	μА
Power-OFF leakage current	I <sub>OFF</sub>		V <sub>IN</sub> = V <sub>IS</sub> = 0 to 4.3 V, See Fig. 11.10	0		l	±2	
Switch OFF-state leakage current	I <sub>SZ</sub>		$V_{IS}$ = 0 to 3.6V, $\overline{OE}$ = $V_{CC}$ , See Fig. 11.11	2.3 to 4.3		l	±2	
ON-resistance	R <sub>ON</sub>	(Note 1)	$V_{IS} = 0 \text{ V}, I_{IS} = 30 \text{ mA},$ See Fig. 11.9	3.0		4.5	6	Ω
			$V_{IS}$ = 0.4 V, $I_{IS}$ = 30 mA, See Fig. 11.9	3.0		4.8	6.7	
			$V_{IS}$ = 3.0 V, $I_{IS}$ = 30 mA, See Fig. 11.9	3.0	_	10	14	
Difference of ON-resistance between switches	ΔR <sub>ON</sub>	(Note 1)	V <sub>IS</sub> = 0.4 V, 1.0 V, I <sub>IS</sub> = 30 mA	3.0	_	0.35	_	
ON-resistance flatness	R <sub>ON(flat)</sub>	(Note 1)	V <sub>IS</sub> = 0 V to 1.0 V, I <sub>IS</sub> = 30 mA	3.0	_	1.3	_	
Quiescent supply current	I <sub>CC</sub>		$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ A	4.3			1	μА
	Δl <sub>CC</sub>		V <sub>IN</sub> = 2.6 V (one input)	4.3	_	_	40	

Note: All typical values are at  $T_a = 25$ °C.

Note 1: Measured by the voltage drop between D+/D- and 1D+/1D-,2D+/2D- pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two pins.

### 10.2. AC Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Propagation delay time	t <sub>PLH</sub> / t <sub>PHL</sub>	(Note 1)	C <sub>L</sub> = 5 pF, See Fig. 11.1	$3.3\pm0.3$		0.25		ns
Turn-ON time (S, OE to output)	t <sub>on</sub>		$R_L$ = 50 $\Omega$ , $C_L$ = 5 pF, See Fig. 11.2		ı	10	20	
Turn-OFF time (S, OE to output)	t <sub>off</sub>				ı	14	24	
Break before make	TBBM		$R_L$ = 50 $\Omega$ , $C_L$ = 5 pF, See Fig. 11.3		2	ı	7	
Skew of opposite transitions of the same output (t <sub>PHL</sub> - t <sub>PLH</sub> )	t <sub>SK(P)</sub>	(Note 1)	C <sub>L</sub> = 5 pF, See Fig. 11.4			0.1		
Output skew (center port to any other port)	t <sub>SK(O)</sub>	(Note 1)	C <sub>L</sub> = 5 pF, See Fig. 11.5		_	0.1	_	

Note: All typical values are at  $T_a = 25$ °C. Note 1: Parameter guaranteed by design.



## 10.3. Analog Switch (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
OFF isolation (non-adjacent)	OIRR		$R_T = 50 \Omega$ , f = 240 MHz, See Fig. 11.6	3.3 ± 0.3	_	-24		dB
Crosstalk (non-adjacent)	Xtalk		$R_T$ = 50 $\Omega$ , f = 240 MHz, See Fig. 11.7		_	-30	-	
-3dB Bandwidth	BW		$R_T = 50 \Omega$ , $C_L = 0 pF$ , See Fig. 11.8		_	1500		MHz

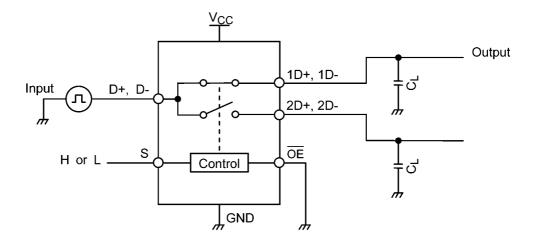
Note: All typical values are at  $T_a = 25$ °C. Parameter guaranteed by design.

## 10.4. Capacitive Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = 25°C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance (OE, S)	C <sub>IN</sub>		V <sub>IN</sub> = 0 V	3.3	3	pF
Switch terminal OFF-capacitance (D+, D-)	C <sub>I/O</sub>		$\overline{OE} = V_{CC}, V_{IS} = 0 V$		3	
Switch terminal OFF-capacitance (1D+, 1D-, 2D+, 2D-)					2	
Switch terminal ON-capacitance			OE = GND, V <sub>IS</sub> = 0 V		5	

Note: Parameter guaranteed by design.

#### 11. AC Test Circuits and Waveforms



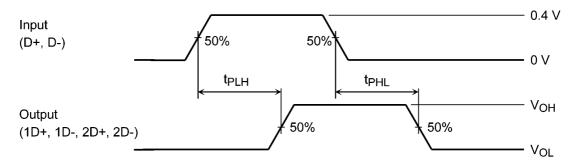
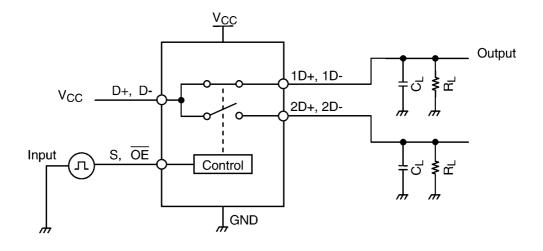


Fig. 11.1 Propagation Delay Time (t<sub>PLH</sub>, t<sub>PHL</sub>)



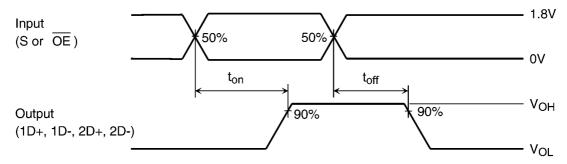
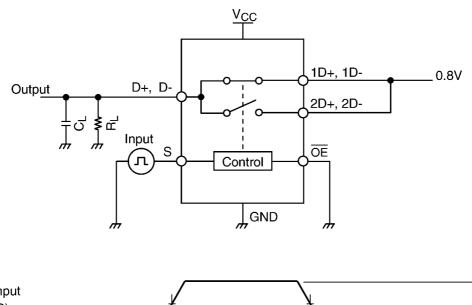


Fig. 11.2 Turn-ON and Turn-OFF Times (ton, toff)



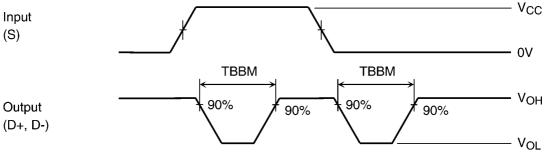
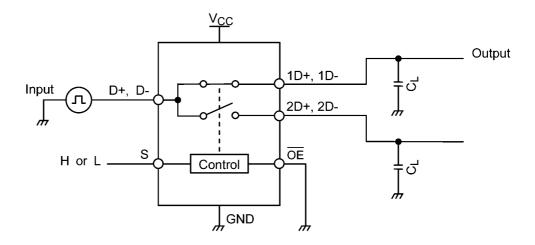


Fig. 11.3 Break Before Make (TBBM)



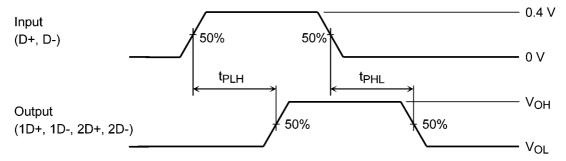


Fig. 11.4 Skew of opposite transitions of the same output  $(t_{SK(P)} = |t_{PHL} - t_{PLH}|)$ 

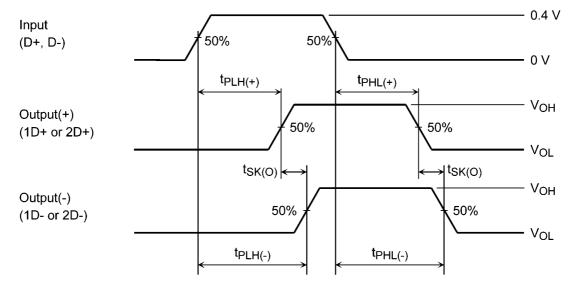


Fig. 11.5 Output Skew (center port to any other port)

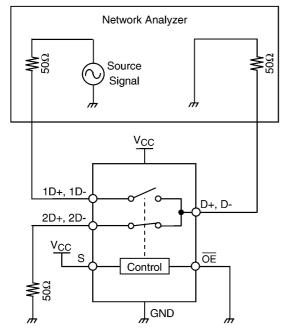


Fig. 11.6 OFF Isolation

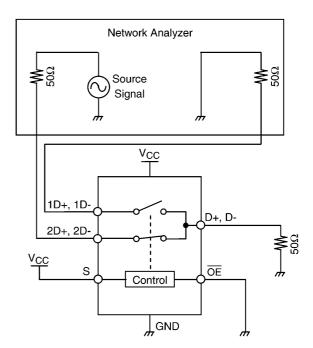


Fig. 11.7 Crosstalk

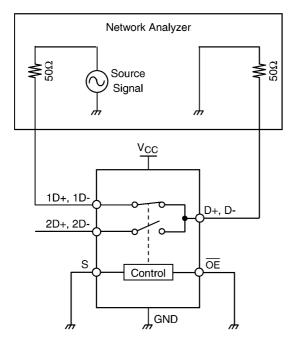


Fig. 11.8 -3dB Bandwidth

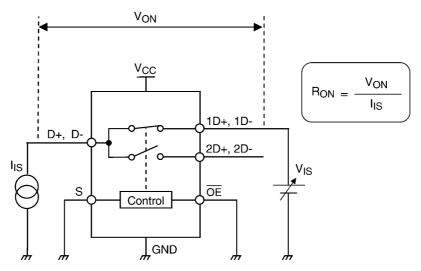


Fig. 11.9 ON-Resistance

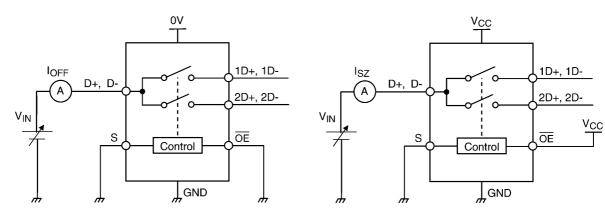


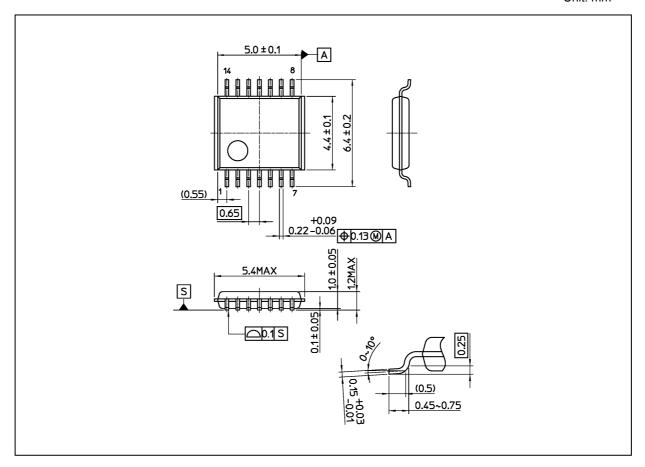
Fig. 11.10 Power-OFF Leakage Current

Fig. 11.11 Switch OFF-state leakage current



## **Package Dimensions**

Unit: mm



Weight: 0.06 g (typ.)

Package Name(s)	
TOSHIBA: TSSOP14-P-0044-0.65S	
Nickname: TSSOP14	



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